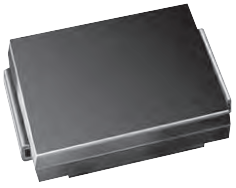
Surface Mount Transient Voltage Suppressors

SMCJ5.0A thru SMCJ188CA

General Semiconductor



DO-214AB (SMC)

PRIMARY CHARACTERISTICS	
V_{BR} uni-directional	6.40 V to 209 V
V_{BR} bi-directional	6.40 V to 209 V
V_{WM}	5.0 V to 170 V
P_{PPM}	1500 W
I_{FSM} (uni-directional only)	200 A
T_J max.	150 °C
Polarity	Uni-directional, bi-directional
Package	DO-214AB (SMCJ)

DEVICES FOR BI-DIRECTION APPLICATIONS

For bi-directional use CA suffix (e.g. SMCJ188CA).

Electrical characteristics apply in both directions.

FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated chip junction
- Available in uni-directional and bi-directional
- Excellent clamping capability
- Very fast response time
- Low incremental surge resistance
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: For definitions of compliance

RoHS COMPLIANT
HALOGEN FREE

TYPICAL APPLICATIONS

Use in sensitive electronics protection against voltage transients induced by inductive load switching and lighting on ICs, MOSFET, signal lines of sensor units for consumer, computer, industrial, and telecommunication.

MECHANICAL DATA

Case: DO-214AB (SMCJ)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T_A = 25 °C unless otherwise noted)			
PARAMETER	**SYMBOL**	**VALUE**	**UNIT**
Peak pulse power dissipation with a 10/1000 µs waveform (fig. 1)	P_{PPM} (1)(2)	1500	W
Peak pulse current with a 10/1000 µs waveform	I_{PPM} (1)	See next table	A
Peak forward surge current 8.3 ms single half sine-wave uni-directional only	I_{FSM} (2)	200	A
Power dissipation on infinite heatsink, T_A = 50 °C	P_D	6.5	W
Operating junction and storage temperature range	T_J, T_{STG}	- 55 to + 150	°C

Notes

(1) Non-repetitive current pulse, per fig. 3 and derated above T_A = 25 °C per fig. 2

(2) Mounted on 0.31" x 0.31" (8.0 mm x 8.0 mm) copper pads to each terminal

ELECTRICAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)

DEVICE TYPE 型号	DEVICE MARKING CODE 设备编码		BREAKDOWN VOLTAGE V_{BR} AT I_T (1) (V) 崩溃电压		TEST CURRENT I_T (mA) 测试电流	STAND-OFF VOLTAGE V_{WM} (V) 对峙电压	MAXIMUM REVERSE LEAKAGE AT V_{WM} I_D (μA) (3) 最大反向漏电	MAXIMUM PEAK PULSE SURGE CURRENT I_{PPM} (A) (2) 最大峰值冲击电流	MAXIMUM CLAMPING VOLTAGEAT I_{PPM} V_C (V) 最大嵌位电压
	UNI	BI	MIN.	MAX.					
(+)SMCJ5.0A (5)	GDE	GDE	6.40	7.07	10	5.0	800	163.0	9.2
(+)SMCJ6.0A	GDG	GDG	6.67	7.37	10	6.0	800	145.6	10.3
(+)SMCJ6.5A	GDK	BDK	7.22	7.98	10	6.5	500	133.9	11.2
(+)SMCJ7.0A	GDM	GDM	7.78	8.60	10	7.0	200	125.0	12.0
(+)SMCJ7.5A	GDP	BDP	8.33	9.21	1.0	7.5	100	116.3	12.9
(+)SMCJ8.0A	GDR	BDR	8.89	9.83	1.0	8.0	50	110.3	13.6
(+)SMCJ8.5A	GDT	BDT	9.44	10.4	1.0	8.5	20	104.2	14.4
(+)SMCJ9.0A	GDV	BDV	10.0	11.1	1.0	9.0	10	97.4	15.4
(+)SMCJ10A	GDX	BDX	11.1	12.3	1.0	10	5.0	88.2	17.0
(+)SMCJ11A	GDZ	GDZ	12.2	13.5	1.0	11	5.0	82.4	18.2
(+)SMCJ12A	GEE	BEE	13.3	14.7	1.0	12	5.0	75.4	19.9
(+)SMCJ13A	GEG	GEG	14.4	15.9	1.0	13	1.0	69.8	21.5
(+)SMCJ14A	GEK	BEK	15.6	17.2	1.0	14	1.0	64.7	23.2
(+)SMCJ15A	GEM	BEM	16.7	18.5	1.0	15	1.0	61.5	24.4
(+)SMCJ16A	GEP	GEM	17.8	19.7	1.0	16	1.0	57.7	26.0
(+)SMCJ17A	GER	GER	18.9	20.9	1.0	17	1.0	54.3	27.6
(+)SMCJ18A	GET	BET	20.0	22.1	1.0	18	1.0	51.4	29.2
(+)SMCJ20A	GEV	BEV	22.2	24.5	1.0	20	1.0	46.3	32.4
(+)SMCJ22A	GEX	BEX	24.4	26.9	1.0	22	1.0	42.3	35.5
(+)SMCJ24A	GEZ	BEZ	26.7	29.5	1.0	24	1.0	38.6	38.9
(+)SMCJ26A	GFE	BFE	28.9	31.9	1.0	26	1.0	35.6	42.1
(+)SMCJ28A	GFG	GFG	31.1	34.4	1.0	28	1.0	33.0	45.4
(+)SMCJ30A	GFK	BFK	33.3	36.8	1.0	30	1.0	31.0	48.4
(+)SMCJ33A	GFM	BFM	36.7	40.6	1.0	33	1.0	28.1	53.3
(+)SMCJ36A	GFP	BFP	40.0	44.2	1.0	36	1.0	25.8	58.1
(+)SMCJ40A	GFR	BFR	44.4	49.1	1.0	40	1.0	23.3	64.5
(+)SMCJ43A	GFT	BFT	47.8	52.8	1.0	43	1.0	21.6	69.4
(+)SMCJ45A	GFV	GFV	50.0	55.3	1.0	45	1.0	20.6	72.7
(+)SMCJ48A	GFX	GFX	53.3	58.9	1.0	48	1.0	19.4	77.4
(+)SMCJ51A	GFZ	GFZ	56.7	62.7	1.0	51	1.0	18.2	82.4
(+)SMCJ54A	GGE	GGE	60.0	66.3	1.0	54	1.0	17.2	87.1
(+)SMCJ58A	GGG	GGG	64.4	71.2	1.0	58	1.0	16.0	93.6
(+)SMCJ60A	GGK	GGK	66.7	73.7	1.0	60	1.0	15.5	96.8
(+)SMCJ64A	GGM	GGM	71.1	78.6	1.0	64	1.0	14.6	103
(+)SMCJ70A	GGP	GGP	77.8	86.0	1.0	70	1.0	13.3	113
(+)SMCJ75A	GGR	GGR	83.3	92.1	1.0	75	1.0	12.4	121
(+)SMCJ78A	GGT	GGT	86.7	95.8	1.0	78	1.0	11.9	126
(+)SMCJ85A	GGV	GGV	94.4	104	1.0	85	1.0	10.9	137
(+)SMCJ90A	GGX	GGX	100	111	1.0	90	1.0	10.3	146
(+)SMCJ100A	GGZ	GGZ	111	123	1.0	100	1.0	9.3	162
(+)SMCJ110A	GHE	GHE	122	135	1.0	110	1.0	8.5	177
(+)SMCJ120A	GHG	GHG	133	147	1.0	120	1.0	7.8	193
(+)SMCJ130A	GHK	GHK	144	159	1.0	130	1.0	7.2	209
(+)SMCJ150A	GHM	GHM	167	185	1.0	150	1.0	6.2	243
(+)SMCJ160A	GHP	GHP	178	197	1.0	160	1.0	5.8	259
(+)SMCJ170A	GHR	GHR	189	209	1.0	170	1.0	5.5	275
SMCJ188A	GHS	GHS	209	231	1.0	188	1.0	4.6	328

Notes

(1) Pulse test: $t_p \leq 50$ ms

(2) Surge current waveform per fig. 3 and derate per fig. 2

(3) For bi-directional types having V_{WM} of 10 V and less, the I_D limit is doubled

(4) All terms and symbols are consistent with ANSI/IEEE C62.35

(5) For the bi-directional SMCJ5.0CA, the maximum V_{BR} is 7.25 V

(6) V_F = 3.5 V at I_F = 25 A (uni-directional only)

(+) Underwriters laboratory recognition for the classification of protectors (QVGQ2) under the UL standard for safety 497B and file number E136766 for both uni-directional and bi-directional devices

THERMAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)			
PARAMETER	**SYMBOL**	**VALUE**	**UNIT**
Typical thermal resistance, junction to ambient	$R_{\theta JA}$ (1)	75	°C/W
Typical thermal resistance, junction to lead	$R_{\theta JL}$	15	°C/W

Note

(1) Mounted on minimum recommended pad layout

ORDERING INFORMATION (Example)				
PREFERRED P/N	**UNIT WEIGHT (g)**	**PREFERRED PACKAGE CODE**	**BASE QUANTITY**	**DELIVERY MODE**
SMCJ5.0A-M3/57T	0.211	57T	850	7" diameter plastic tape and reel
SMCJ5.0A-M3/9AT	0.211	9AT	3500	13" diameter plastic tape and reel

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

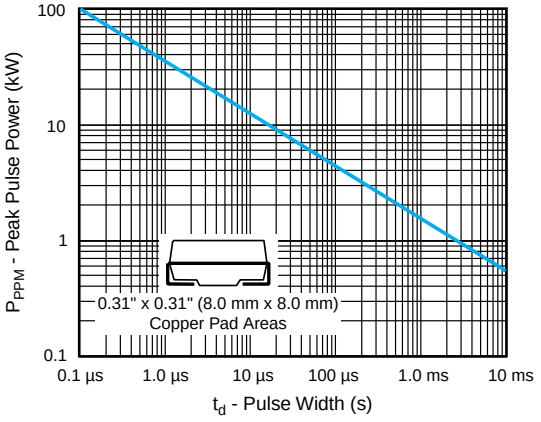


Fig. 1 - Peak Pulse Power Rating Curve

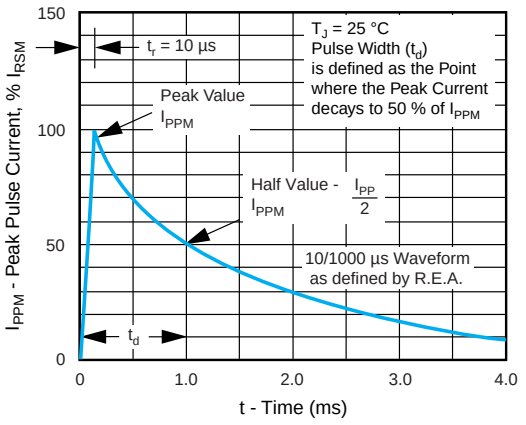


Fig. 3 - Pulse Waveform

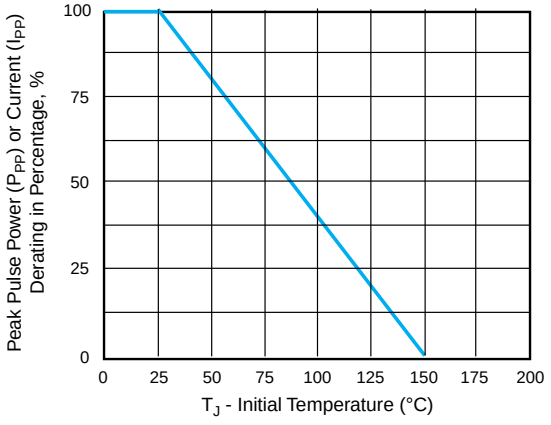


Fig. 2 - Pulse Power or Current vs. Initial Junction Temperature

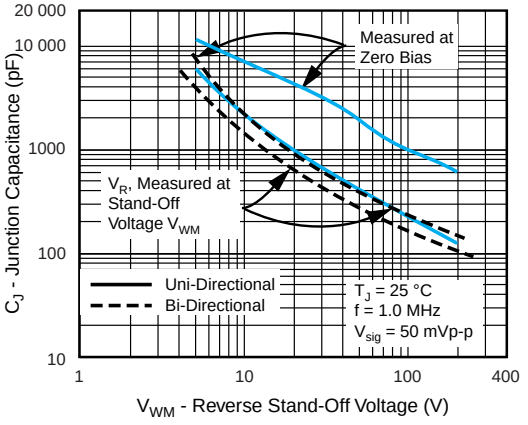


Fig. 4 - Typical Junction Capacitance

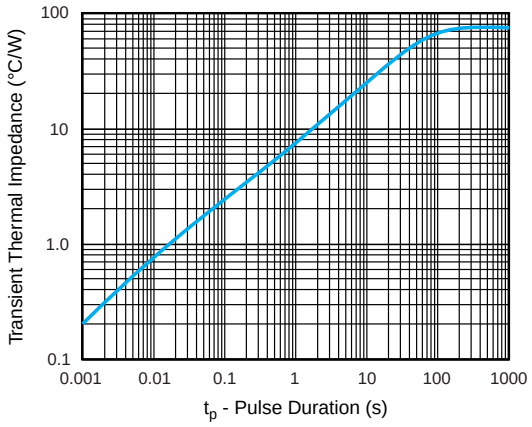


Fig. 5 - Typical Transient Thermal Impedance

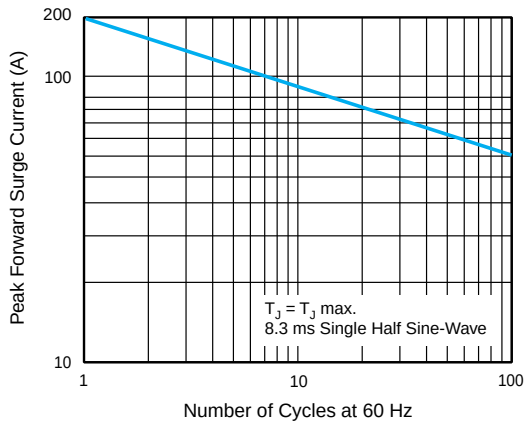
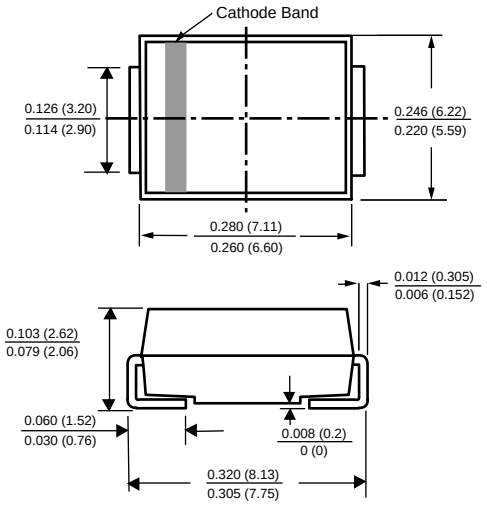


Fig. 6 - Maximum Non-Repetitive Forward Surge Current
Uni-Directional Only

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AB (SMC J-Bend)



Mounting Pad Layout